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## ON Semiconductor®

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### 2N5638

### **N-Channel Switch**

- This device is designed for low level analog switchng, sample and hold circuits and chopper stabilized amplifiers.
- Sourced from process 51.



1. Drain 2. Source 3. Gate

### Absolute Maximum Ratings \* T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Value	Units
$V_{DG}$	Drain-Gate Voltage	30	V
V <sub>GS</sub>	Gate-Source Voltage	-30	V
I <sub>GF</sub>	Forward Gate Current	50	mA
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range	-55 ~ +150	°C

<sup>\*</sup> These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

- These ratings are based on a maximum junction temperature of 150 degrees C.
   These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

### Electrical Characteristics T<sub>C</sub>=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units	
Off Charac	Off Characteristics						
V <sub>(BR)GSS</sub>	Gate-Source Breakdown Voltage	$V_{DS} = 0, I_{G} = -10\mu A$ -30			V		
I <sub>GSS</sub>	Gate Reverse Current	V <sub>GS</sub> = -15V, V <sub>DS</sub> = 0			-1.0	nA	
I <sub>D(off)</sub>	Drain Cutoff Leakage Current	V <sub>DS</sub> = 12V, V <sub>GS</sub> = 15V			1.0	nA	
On Characteristics							
I <sub>DSS</sub>	Zero-Gate Voltage Drain Current *	$V_{DS} = 20V, I_{GS} = 0$	50			mA	
r <sub>DS(on)</sub>	Drain-Source On Resistance	$V_{GS} = 0V, I_{D} = 1.0 \text{mA}$			30	Ω	
Small Signal Characteristics							
r <sub>ds(on)</sub>	Drain-Source On Resistance	$V_{DS} = V_{GS} = 0$ , f = 1.0kHz			30	Ω	
C <sub>iss</sub>	Input Capacitance	$V_{DS} = 0$ , $V_{GS} = 12V$ , $f = 1.0MHz$			10	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance	$V_{DS} = 0V, V_{GS} = 12V, f = 1.0MHz$			4.0	pF	
Switching Characteristics							
t <sub>d(on)</sub>	Trun On Delay Time	$V_{DD} = 10V, V_{GS(on)} = 0$			4.0	ns	
t <sub>r</sub>	Rise Time	$V_{GS(off)} = -12, I_{D(on)} = 12mA$ $R_G = 50\Omega$			5.0	ns	
t <sub>d(off)</sub>	Trun Off Delay Time			5.0	ns		
t <sub>f</sub>	Fall Time				10	ns	

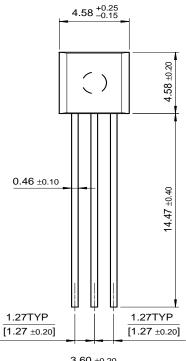
<sup>\*</sup> Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 1.0%

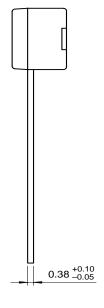
### Thermal Characteristics T<sub>A</sub>=25°C unless otherwise noted

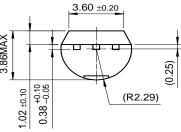
Symbol	Parameter	Max.	Units
P <sub>D</sub>	Total Device Dissipation	350	mW
_	Derate above 25°C	2.8	mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	125	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	357	°C/W

## **Package Dimensions**

TO-92







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Datasheet Identification	Product Status	Definition
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